



ICOPS 2010 Job Placement Center

<http://eng.odu.edu/icops2010/job.shtml>

A job placement center will be set up at the 2010 International Conference on Plasma Science. The placement center serves to facilitate contact between individuals seeking work and prospective employers (including those in private industry, federal labs and universities).

The placement center is a free, voluntary service that serves several related fields including: plasma physics, pulsed power, high power microwaves and fusion.

At the conference there will be an area for displaying job postings received. There will also be a book of resumes available for prospective employers to search. Interviews will be possible onsite if candidates/recruiters are available but **attendance at the conference is not a requirement to participate in the placement center!**

In previous years the placement center has been able to help engineers, physicists, mathematicians and technologists make contact with prospective employers.

Individuals interested in employment opportunities should send their resumes via email to the address below. Please include ICOPS 2010 in the subject line. Resumes should include citizenship (needed for positions in certain research labs) and be limited to one page to be most useful. If an individual will not be attending the conference please note this when sending in the resume. Again, participation in the conference is not required to participate in the job fair.

Employers interested in filling positions should send a job posting via email marked ICOPS 2010 to the address below. Please make a note on the posting if a position has special requirements such as extended travel duties or the ability to obtain a security clearance. If an employer would like to interview applicants at the conference, please note this when sending in the job posting (space will be provided for interviews). Participants with questions should feel free to contact Will White at the phone number or email address below.

Will White
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